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**Amendments to the Claims**

Claims 1-20 (Cancelled).

21. (Currently amended) A physical vapor deposition target consisting essentially of:

aluminum having a purity of at least 99.999 atomic percent; and less than or equal to 1000 ppm of one or more dopant materials, the dopant materials including at least one element selected from the group consisting of Ac, As, B, Ba, Be, Bi, C, Ca, Cd, Ge, In, N, O, P, Pb, Po, Pu, Ra, Rf, S, Sb, Se, Sn, Sr, Te, Tl, and Zn; the dopant material optionally further comprising one or more elements selected from the group consisting of As, Ag, As, B, Ba, Be, Bi, C, Ca, Cd, Ce, Co, Cr, Cu, Dy, Er, Eu, Fe, Ga, Gd, Ge, Hf, Ho, Ir, La, Lu, Mg, Mn, Mo, N, Nb, Nd, Ni, O, Os, P, Pb, Pd, Pm, Po, Pr, Pt, Pu, Ra, Rf, Rh, Ru, S, Sb, Sc, Se, Si, Sm, Sn, Sr, Ta, Tb, Te, Ti, Tl, Tm, V, W, Y, Yb, Zn and Zr; the physical vapor deposition target having an average grain size of less than 100 microns.

22. (Original) The physical vapor deposition target of claim 21 having an average grain size of less than or equal to 45 microns.

23. (Currently amended) The physical vapor deposition target of claim 21 consisting of Al, the at least one element selected from the group consisting of Ac, As, B,

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Ba, Be, Bi, C, Ca, Cd, Ge, In, N, O, P, Pb, Po, Pu, Ra, Rf, S, Sb, Se, Sn, Sr, Te, Ti, and Zn; and less than 100 ppm of one or more of Si, Sc, Ti and Hf.

24. (Currently amended) The physical vapor deposition target of claim 21 consisting of Al, the at least one element selected from the group consisting of Ac, As, B, Ba, Be, Bi, C, Ca, Cd, Ge, In, N, O, P, Pb, Po, Pu, Ra, Rf, S, Sb, Se, Sn, Sr, Te, Ti, and Zn; and from 10 ppm to 100 ppm of one or more of Si, Sc, Ti and Hf.

25. (Currently amended) The physical vapor deposition target of claim 21 consisting of Al, the at least one element selected from the group consisting of Ac, As, B, Ba, Be, Bi, C, Ca, Cd, Ge, In, N, O, P, Pb, Po, Pu, Ra, Rf, S, Sb, Se, Sn, Sr, Te, Ti, and Zn, and from 10 ppm to 100 ppm of Sc; the target having an average grain size of less than or equal to 45 microns.

26. (Currently amended) The physical vapor deposition target of claim 21 consisting of Al, the at least one element selected from the group consisting of Ac, As, B, Ba, Be, Bi, C, Ca, Cd, Ge, In, N, O, P, Pb, Po, Pu, Ra, Rf, S, Sb, Se, Sn, Sr, Te, Ti, and Zn, and from 10 ppm to 100 ppm of Si; the target having an average grain size of less than or equal to 35 microns.

27. (Currently amended) The physical vapor deposition target of claim 21 consisting of Al, the at least one element selected from the group consisting of Ac, As, B,

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Ba, Be, Bi, C, Ca, Cd, Ge, In, N, O, P, Pb, Po, Pu, Ra, Rf, S, Sb, Se, Sn, Sr, Te, Tl, and Zn, and from 10 ppm to 100 ppm of Ti.

28. (Currently amended) The physical vapor deposition target of claim 21 consisting of Al, the at least one element selected from the group consisting of Ac, As, B, Ba, Be, Bi, C, Ca, Cd, Ge, In, N, O, P, Pb, Po, Pu, Ra, Rf, S, Sb, Se, Sn, Sr, Te, Tl, and Zn, and from 10 ppm to 100 ppm of Hf.

Claims 29-31 (Cancelled).

32. (Currently amended) A physical vapor deposition target made by a process including casting, consisting essentially of:  
aluminum; and  
less than or equal to 1000 ppm of one or more dopant materials, the dopant materials including at least one element selected from the group consisting of Ac, As, B, Ba, Be, Bi, C, Ca, Cd, Ge, In, N, O, P, Pb, Po, Pu, Ra, Rf, S, Sb, Se, Sn, Sr, Te, Tl, and Zn; the dopant material optionally further comprising one or more elements selected from the group consisting of Ae, Ag, As, B, Ba, Be, Bi, C, Ca, Cd, Ce, Co, Cr, Cu, Dy, Er, Eu, Fe, Ga, Gd, Ge, Hf, Ho, In, Ir, La, Lu, Mg, Mn, Mo, N, Nb, Nd, Ni, O, Os, P, Pb, Pd, Pm, Pe, Pr, Pt, Ru, Ra, Rf, Rh, Ru, S, Sb, Sc, Se, Si, Sm, Sn, Sr, Ta, Tb, Te, Ti, Tl, Tm, V, W, Y, Yb, Zn and Zr; the physical vapor deposition target having an average grain size of less than 100 microns.

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33. (Previously presented) The physical vapor deposition target of claim 32 having a size of greater than or equal to 860 x 910 x 19 mm<sup>3</sup>.

34. (Previously presented) The physical vapor deposition target of claim 32 wherein the physical vapor deposition target is monolithic.

35. (Currently amended) A physical vapor deposition target made by a process including casting and equal channel angular extrusion, the target comprising:  
aluminum having an atomic purity of at least 99.99%; and  
at least one dopant material selected from the group consisting of Ac, As, B, Ba, Be, Bi, C, Ca, Cd, Ge, In, N, O, P, Pb, Po, Pu, Ra, Rf, S, Sb, Se, Sn, Sr, Te, Tl and Zn; and  
at least one element selected from the group consisting of Ti, Ta, W, Sc, Co, Mo, and Hf.

36. (Previously presented) The physical vapor deposition target of claim 35 wherein the total amount of the at least one element comprised by the target is from greater than 0 ppm to less than 1000 ppm.

37. (Currently amended) The physical vapor deposition target of claim 35 wherein the target consists essentially of the aluminum, the at least one dopant, and the at least one element.

Claims 38-39 (Cancelled).

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40. (Currently amended) A physical vapor deposition target made by a process including casting, consisting essentially of:

aluminum; and

less than or equal to 1000 ppm of elements selected from the group consisting of Ac, Ag, As, B, Ba, Be, Bi, C, Ca, Cd, Ce, Co, Cr, Cu, Dy, Er, Eu, Fe, Ga, Gd, Ge, Hf, Ho, In, Ir, La, Lu, Mg, Mn, Mo, N, Nb, Nd, Ni, O, Os, P, Pb, Pd, Pm, Po, Pr, Pt, Pu, Ra, Rf, Rh, Ru, S, Sb, Se, Si, Sm, Sn, Sr, Ta, Tb, Te, Ti, Tl, Tm, V, W, Y, Yb, Zn and Zr, at least one of the elements being selected from the group consisting of Ac, As, B, Ba, Be, Bi, C, Ca, Cd, Ge, In, N, O, P, Pb, Po, Pu, Ra, Rf, S, Sb, Se, Sn, Sr, Te, Tl, and Zn, the physical vapor deposition target having an average grain size of less than 100 microns.

41. (Previously presented) The physical vapor deposition target of claim 40 wherein the aluminum has a purity of at least 99.99 atomic percent.

42. (Currently amended) A physical vapor deposition target consisting essentially of:

aluminum having a purity of at least 99.99 atomic percent; and

less than or equal to 1000 ppm of one or more dopant materials comprising elements selected from the group consisting of Ac, Ag, As, B, Ba, Be, Bi, C, Ca, Cd, Ce, Co, Cr, Cu, Dy, Er, Eu, Fe, Ga, Gd, Ge, Hf, Ho, In, Ir, La, Lu, Mg, Mn, Mo, N, Nb, Nd, Ni, O, Os, P, Pb, Pd, Pm, Po, Pr, Pt, Pu, Ra, Rf, Rh, Ru, S, Sb, Sc, Se, Si, Sm, Sn, Sr, Ta, Tb, Te, Ti, Tl, Tm, V, W, Y, Yb, Zn and Zr; at least one of the dopant materials being selected from the group consisting of Ac, As, B, Ba, Be, Bi, C, Ca, Cd, Ge, In, N, O, P, Pb, Po, Pu,

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Ra, Rf, S, Sb, Se, Sn, Sr, Te, Tl and Zn; the physical vapor deposition target having an average grain size of greater than at least 20 microns and less than 100 microns.

43. (Previously presented) The physical vapor deposition target of claim 42 wherein the aluminum has a purity of at least 99.995 atomic percent.

44. (Previously presented) The physical vapor deposition target of claim 42 having less than or equal to 100 ppm of the one or more dopant materials.

45. (New) The physical vapor deposition target of claim 40 wherein the at least one element is Be.

46. (New) The physical vapor deposition target of claim 40 wherein the at least one element is Ge.